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	PATENT AND TRADEMARK OFFICE	
	ATTY. DOCKET	SERIAL NO.
	NO. 32784US4	10/637,154
	APPLICANT: Christoph Widmer et al.	
	FILING DATE:	GROUP ART UNIT:
	August 8, 2003	

U.S. PATENT DOCUMENTS							
Examiner Initial		Document No.	Date	Name	Class	Subclass	Filing Date If Appropriate
	A						
	B						
	C						
	D						
	E						
	F						
	G						
	H						
	I						
	J						
	K						

FOREIGN PATENT DOCUMENTS							
		Document No.	Date	Country	Class	Subclass	Translation
S.M.J	L	40 41 105A	6/1992	DE			cited in ESR
S.M.J	M	01 05207A	1/2001	WO			cited in ESR
	N						
	P						

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)		
R		
S		
T		

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U.S. PATENT DOCUMENTS

Examiner Initial		Document No.	Date	Name	Class	Subclass	Filing Date If Appropriate
SMB	A	5,487,012	1/1996	Topholm et al.	700	163	10/94
	B	5,068,902	11/1991	Ward	381	328	3/1989
	C	5,056,204	10/1991	Bartschi	29	896.21	5/1990
	D	5,641,448	6/1997	Yeung et al.	264	401	
	E	4,984,277	1/1991	Bisgaard et al.	381	325	
	F	5,979,589	11/1999	Aceti	181	135	
	G	4,091,067	5/1978	Kramer et al.	264	222	
↓	H	6,495,214	12/2002	Prix et al.	427	510	
I							
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		Document No.	Date	Country	Class	Subclass	Translation
SMB	L	0 516 808 B1	1/1996	EP			Claims Only
↓	M	00/34739	6/2000	WO			Cited in ISR
↓	N	0 010 200 A	3/1998	BE			Cited in ISR
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OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)

R	Article: "The Selective Laser Sintering Process Third Generation Desk Top Manufacturing," DTM Corporation, 6/4/1990
S	
T	

Examiner:

SMB

Date Considered

5/7/04

*Examiner:

Initial if reference considered, regardless of whether citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.